# LINQALLOY SP-SAC305



## SAC305 Solder Paste

- No-clean solder paste
- Lead Free and RoHS compliant
- **Excellent printing capabilities**

LINQALLOY-SP-SAC305 is a lead free solder paste comprised of 96.5% tin, 3% silver, 0.5% copper that has been designed for Surface Mount Technology(SMT). This Solder Paste is being offered in two options, No-Clean and Water Soluble.

No-clean solder paste is designed for applications where post-soldering cleaning is unnecessary, providing minimal, non-conductive residues. On the other hand, the water-soluble solder paste is crafted with refined tin powder that allows you to clean flux residue left after the reflow process.

This solder paste is crafted with refined tin powder that allows for exceptional printing capabilities and minimal oxide content. The enhanced flux content (higher %) guarantees higher reliability and leaves behind minimal residues post reflow, resulting in exceptionally high insulation resistance and excellent reliability.

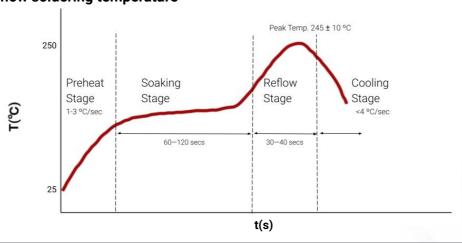
## **Chemical composition**

Alloy	Chemical composition (wt.%)											
	Sn	Ag	Cu	Ni	Zi	Al	Sb	Fe	As	Bi	Cd	Pb
Sn96.5-Ag3.0 -Cu0.5	Bal.	3.0	0.5	0 ~ 0.01	0.001 [Max]	0.001 [Max]	0.05 [Max]	0.02 [Max]	0.03 [Max]	0.10 [Max]	0.01 [Max]	0.01 [Max]

## Recommended reflow process

Preheating Stage		Soakin	g Stage	Reflow	/ Stage	Cooling Stage		
Preheat Rate °C/sec	Temp. °C	Soaking time secs		Reflow time secs Peak Temp.		Cooling Rate °C/sec		
1 - 3	150	60-120	150-190	30-40	245°C ±10	<4		

## Recommended reflow soldering temperature



### Europe

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### **South East Asia**

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## **Technical Specifications**

ltom	Specifica			
ltem —	No-Clean Water-Soluble		Standard	
Alloy	SAC30	JIS-Z-3282		
Melting Point [°C]	217	-		
Powder Type	Type 3 - T	IPC-TM-650,2.2.14		
Metal Content [%]	89	IPC-TM-650 2.2.20		
Flux Content wt [%]	11.0 ± (	JIS-Z-3197,8.1.2		
Viscosity @ 25℃ [Pa.s]	160 ~ 230	160 ~ 230	Malcom PCU 205	
Halogen Content	ROL0 / ROL1	ROL0 / ROL1	J-STD-004B	
Copper corrosion	PASS	JIS-Z-3197,8.4.		
Copper Mirror	PASS	IPC-TM-650,2.3.32		
SIR [Ω]	PASS	IPC-TM-650 2.6.3.3		

## Storage and handling:

## **Before Opening:**

- Storage:
  - Temperature: Ideally, store unopened solder paste in a refrigerator at 0°C to 12°C (32°F to **54°F)**. This helps prolong shelf life [6 months from the manufacturing date].
  - First-In, First-Out (FIFO): Use older solder paste first to avoid expiration.
  - Avoid exposing the paste to direct sunlight or extreme temperatures.
- **Transportation:** Keep solder paste cool during transportation. Use insulated containers if necessary.
- Solder paste can endure temperatures up to 35°C for 7 days in transit.

## Opening and Use:

- Temperature equilibration: Before opening, allow the sealed container to reach room temperature (19°C to 25°C or 66°F to 77°F) for 3-4 hours. Avoid using forced heating.
- **Opening: Do not** use the paste if it is frozen.
- Use: Use the paste within its open time [usually 3 days after opening]. Unused paste should be discarded after this period.
- Hygiene: Maintain a clean and dust-free environment while handling the paste.
- Mixing: If necessary, mix the paste gently for a short period [3 to 5 minutes] before use to ensure uniform consistency. Do not overmix.
- Our packaging is engineered to keep the paste below 35°C for a minimum of 3 days.

## After Opening:

- Resealing: After use, tightly reseal the container to minimize moisture absorption and oxidation.
- Storage: Do not refrigerate the paste once opened. Store it at room temperature.
- Labeling: Consider labeling opened containers with the date and time of opening for better tracking.

## **Typical Package**

500g Bottle

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